NSN 5962-00-150-1150

Memory Microcircuit - Page 1 of 1



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Body Length:

Between 1.315 inches and 1.415 inches

Body Width:

Between 0.590 inches and 0.610 inches

Body Height:

Between 0.125 inches and 0.165 inches

Maximum Power Dissipation Rating:

800.0 milliwatts

Operating Tempurature Range:

-25.0/+85.0 degrees celsius

Storage Tempurature Range:

-65.0/+150.0 degrees celsius

Features Provided:

Hermetically sealed and monolithic and negative outputs and programmable and programmed and w/buffered output and w/enable

Inclosure Material:

Ceramic and glass

Inclosure Configuration:

Dual-in-line

Output Logic Form:

P-type metal oxide-semiconductor logic

Input Circuit Pattern:

16 input

Terminal Surface Treatment:

Solder

Voltage Rating And Type Per Characteristic:

0.3 volts power source

Memory Device Type:

Rom

Memory Capacity:

Unknown

Test Data Document:

00752-373729 drawing (this is the basic governing drawing, such as a contractor drawing, original equipment manufacturer drawing, etc.;

excludes any specification, standard or other document that may be referenced in a basic governing drawing)

Terminal Type And Quantity:

28 printed circuit

Shelf Life:

N/a

Unit Of Measure:

Demilitarization:

Yes - demil/mli

Fiig:

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